



## Dual N-Channel 20-V (D-S) MOSFET

## PRODUCT SUMMARY

$V_{DS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
20	0.030 @ $V_{GS} = 4.5$ V	7.7
	0.036 @ $V_{GS} = 2.5$ V	7.0
	0.045 @ $V_{GS} = 1.8$ V	6.3

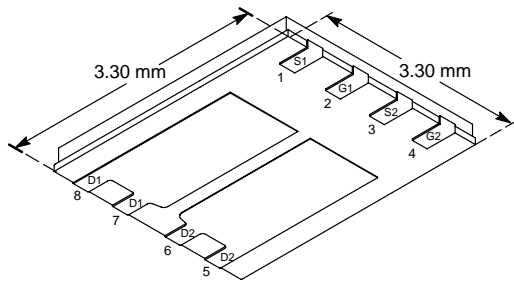
## FEATURES

- TrenchFET® Power MOSFETs: 1.8-V Rated
- New Low Thermal Resistance PowerPAK™ Package with Low 1.07-mm Profile

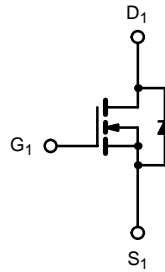
## APPLICATIONS

- HDD Spindle Drive

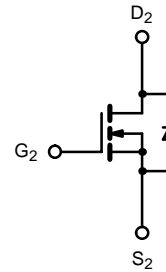
PowerPAK™ 1212-8



Bottom View



N-Channel MOSFET



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	20		V
Gate-Source Voltage		V <sub>GS</sub>	± 8		
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 25°C	I <sub>D</sub>	7.7	5.3	A
	T <sub>A</sub> = 85°C		5.5	3.8	
Pulsed Drain Current		I <sub>DM</sub>	20		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.3	1.1	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	P <sub>D</sub>	2.8	1.3	W
	T <sub>A</sub> = 85°C		1.5	0.85	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C

## THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$t \leq 10$ sec	$R_{thJA}$	35	44	$^\circ\text{C/W}$
	Steady State		75	94	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	4	5	

## Notes

a. Surface Mounted on 1" x 1" FR4 Board.

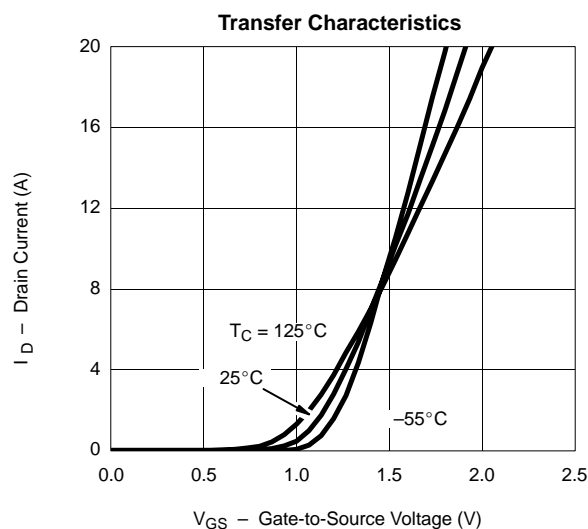
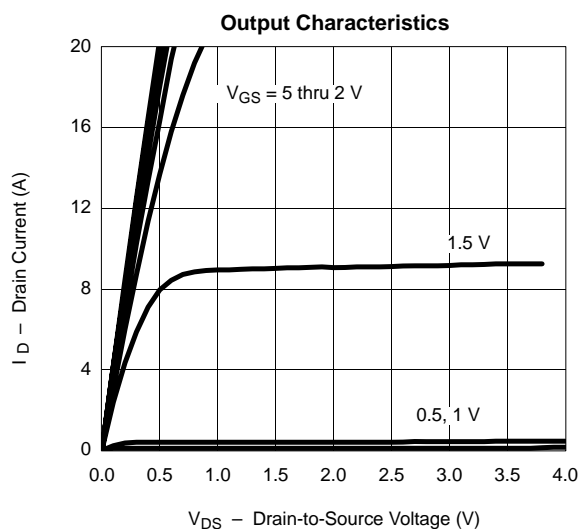
**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

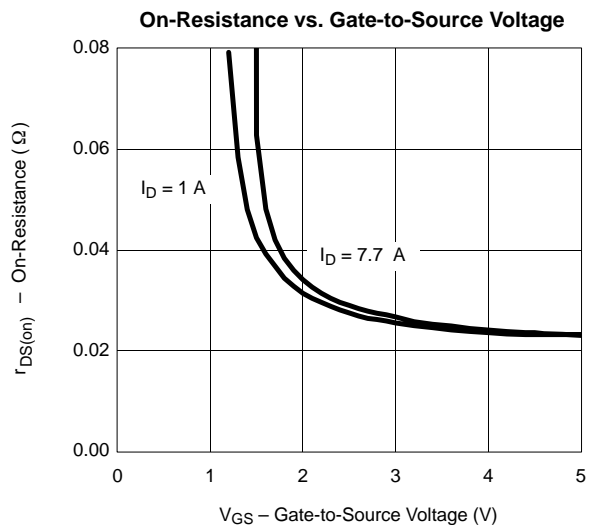
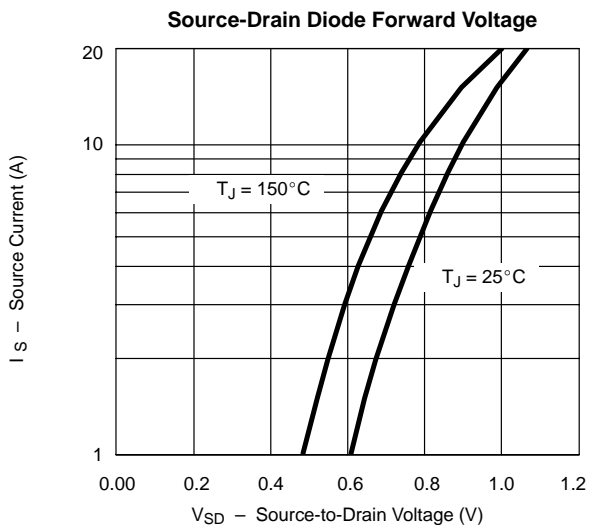
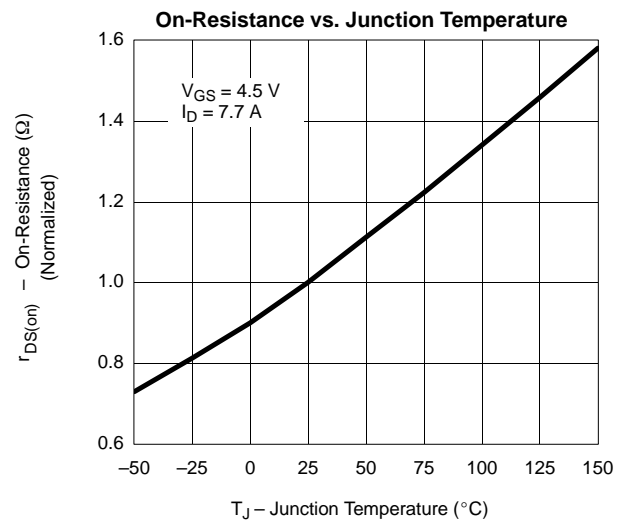
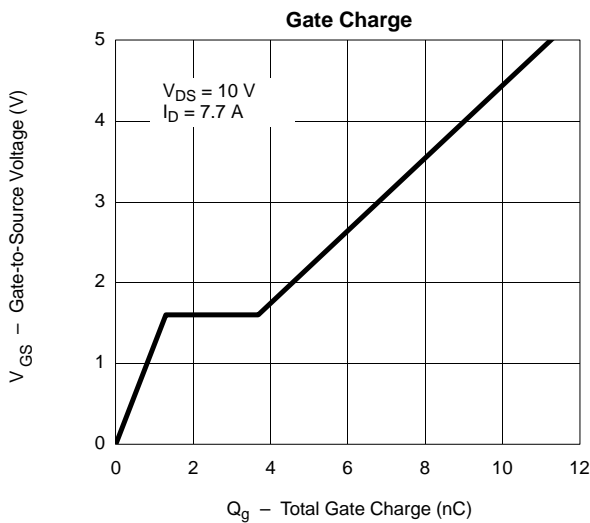
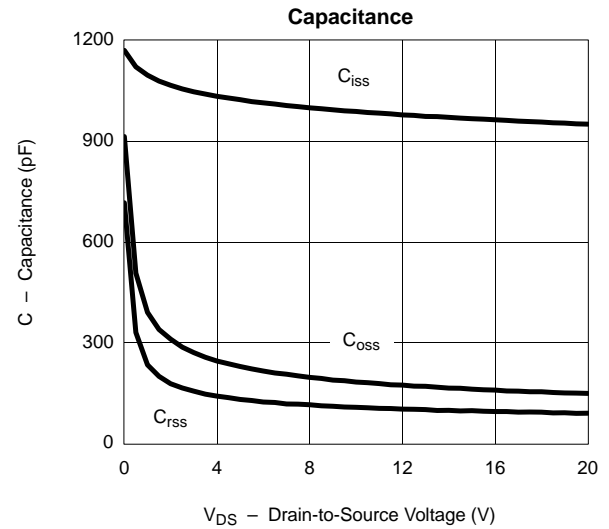
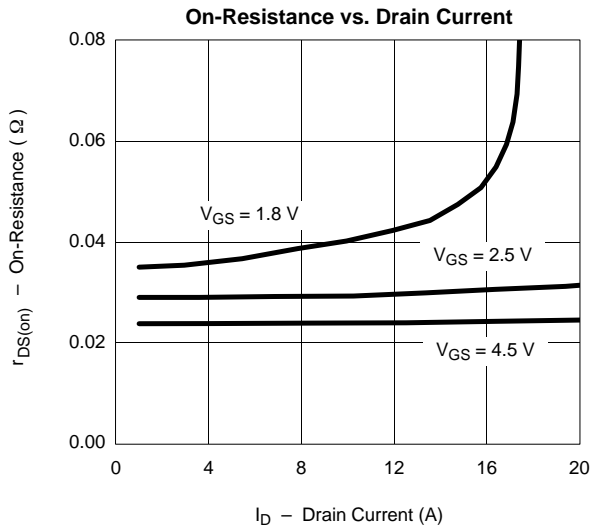
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 935\ \mu\text{A}$	0.45			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\ \text{V}$ , $V_{GS} = \pm 8\ \text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 16\ \text{V}$ , $V_{GS} = 0\ \text{V}$			1	$\mu\text{A}$
		$V_{DS} = 16\ \text{V}$ , $V_{GS} = 0\ \text{V}$ , $T_J = 85^\circ\text{C}$			5	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}$ , $V_{GS} = 4.5\ \text{V}$	20			A
Drain-Source On-State Resistance <sup>a</sup>	$r_{DS(on)}$	$V_{GS} = 4.5\ \text{V}$ , $I_D = 7.7\ \text{A}$		0.025	0.030	$\Omega$
		$V_{GS} = 2.5\ \text{V}$ , $I_D = 7.0\ \text{A}$		0.030	0.036	
		$V_{GS} = 1.8\ \text{V}$ , $I_D = 1\ \text{A}$		0.037	0.045	$\Omega$
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 10\ \text{V}$ , $I_D = 7.7\ \text{A}$		23		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 2.3\ \text{A}$ , $V_{GS} = 0\ \text{V}$		0.70	1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = 10\ \text{V}$ , $V_{GS} = 4.5\ \text{V}$ , $I_D = 7.7\ \text{A}$		10.2	15	nC
Gate-Source Charge	$Q_{gs}$			1.3		
Gate-Drain Charge	$Q_{gd}$			2.4		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 10\ \text{V}$ , $R_L = 10\ \Omega$ $I_D \cong 1\ \text{A}$ , $V_{GEN} = 4.5\ \text{V}$ , $R_G = 6\ \Omega$		15	23	ns
Rise Time	$t_r$			50	75	
Turn-Off Delay Time	$t_{d(off)}$			60	90	
Fall Time	$t_f$			45	68	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 2.3\ \text{A}$ , $di/dt = 100\ \text{A}/\mu\text{s}$		40	80	

## Notes

a. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

b. Guaranteed by design, not subject to production testing.

**TYPICAL CHARACTERISTICS ( $25^\circ\text{C}$  UNLESS NOTED)**

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